

TLOU113P(F), TLSU113P(F), TLYU113P(F)

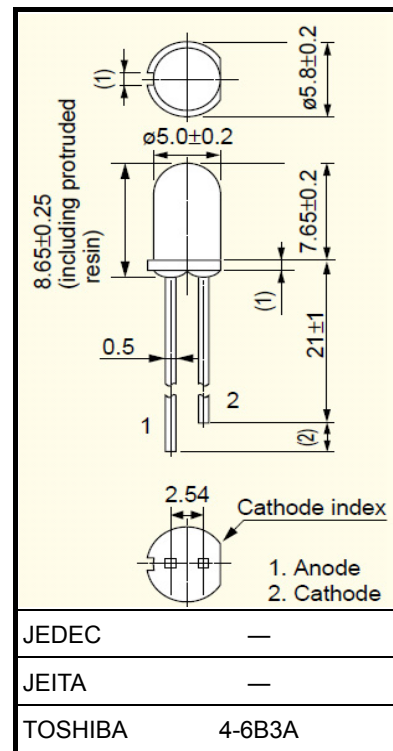
Panel Circuit Indicator

Unit in mm

- Lead(Pb)-free products (lead: Sn-Ag-Cu)
- 5mm package
- InGaAlP LED
- Without stand-offs
- All plastic mold type
- Colored transparent lens
- Lineup: 3 colors (red, orange, yellow)
- Suitable for high-brightness and less electricity consumption.
- All plastic molded lens, provides an excellent on-off contrast ratio.
- Applications: Backlight, light for decoration, switches, various indicator, personal equipment

Lineup

Product	Color	Material
TLOU113P(F)	Orange	InGaAlP
TLSU113P(F)	Red	InGaAlP
TLYU113P(F)	Yellow	InGaAlP



Weight: 0.31 g(Typ.)

Absolute Maximum Ratings (Ta = 25°C)

Product	Forward Current I _F (mA)	Reverse Voltage V _R (V)	Power Dissipation P _D (mW)	Operating Temperature T _{opr} (°C)	Storage Temperature T _{stg} (°C)
TLOU113P(F)	30	4	72	-20~75	-30~100
TLSU113P(F)	30	4	72	-20~75	-30~100
TLYU113P(F)	30	4	75	-20~75	-30~100

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Electrical Characteristics (Ta = 25°C)

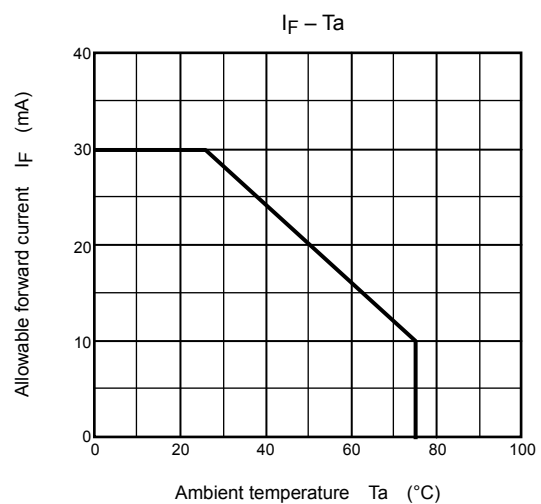
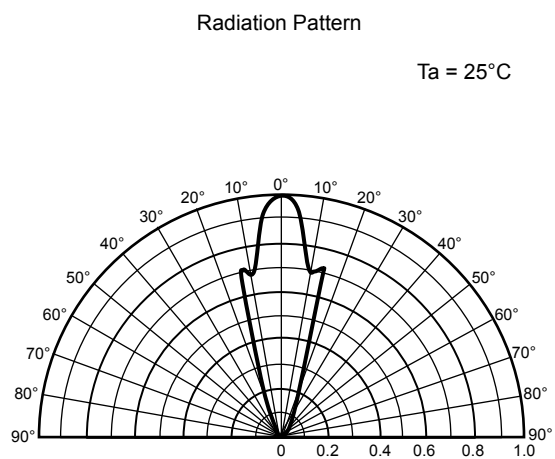
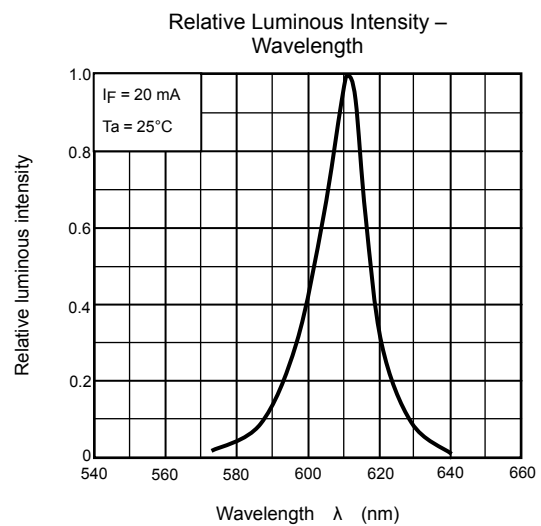
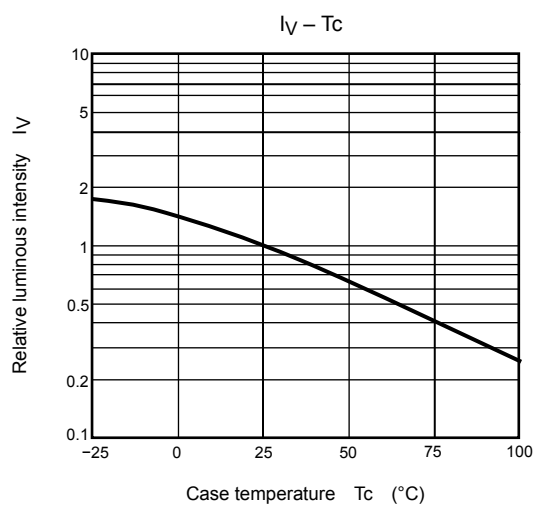
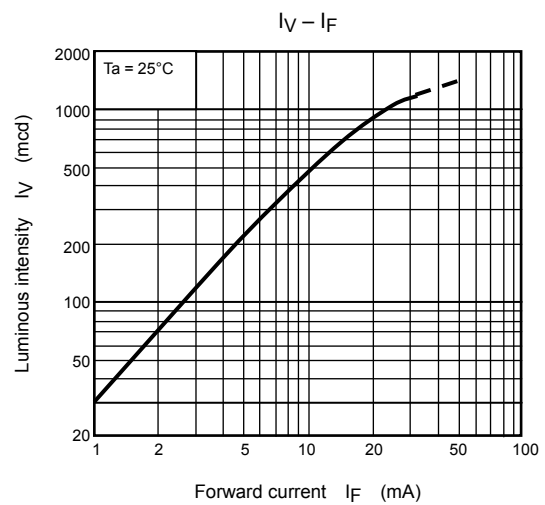
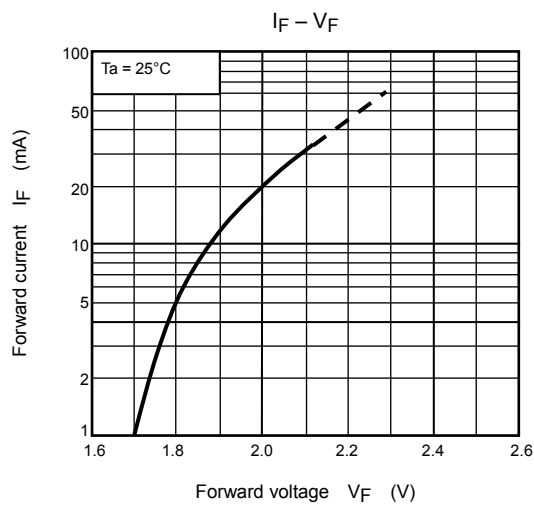
Product	Typ.Emission Wavelength		Luminous Intensity I _V	Min	Typ.	I _F	Forward Voltage V _F			Reverse Current I _R	
	λ _p	Δλ					Typ.	Max	I _F	Max	V _R
TLOU113P(F)	(612)	15	20	272	900	20	2.0	2.4	20	50	4
TLSU113P(F)	(636)	17	20	272	700	20	2.0	2.4	20	50	4
TLYU113P(F)	(590)	13	20	153	500	20	2.1	2.5	20	50	4
Unit	nm		mA		mcd		V		mA		μA

Precaution

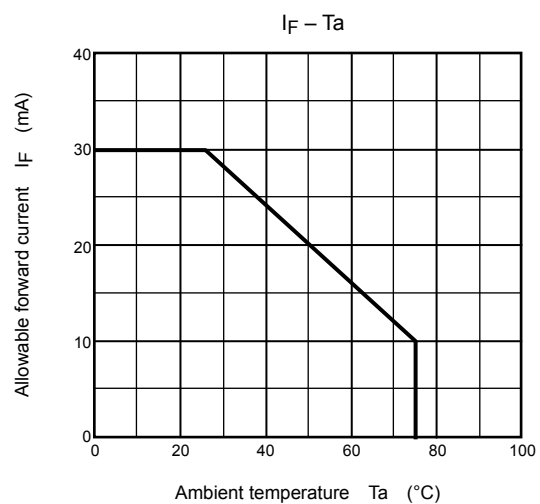
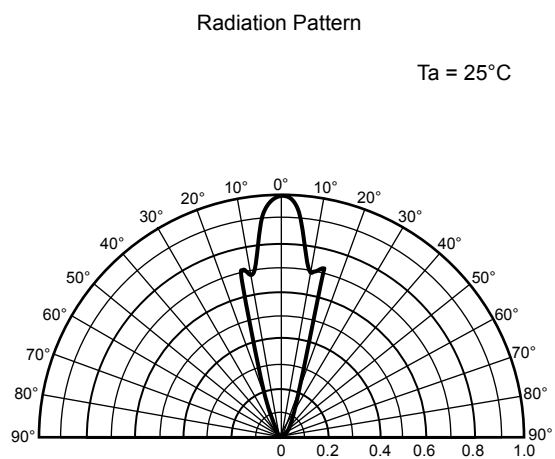
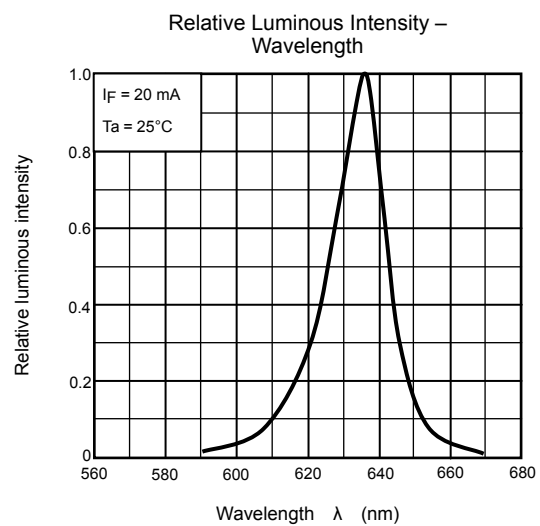
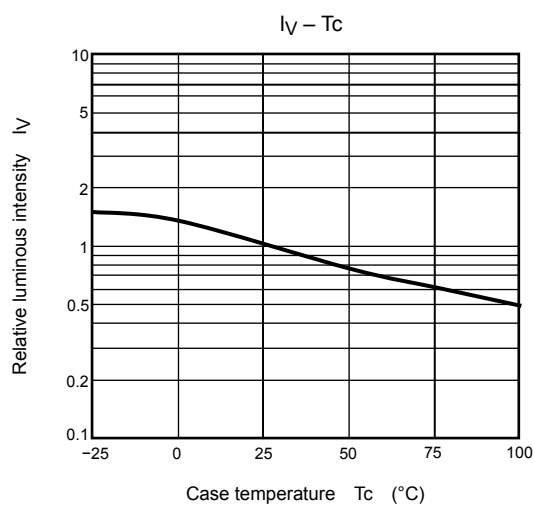
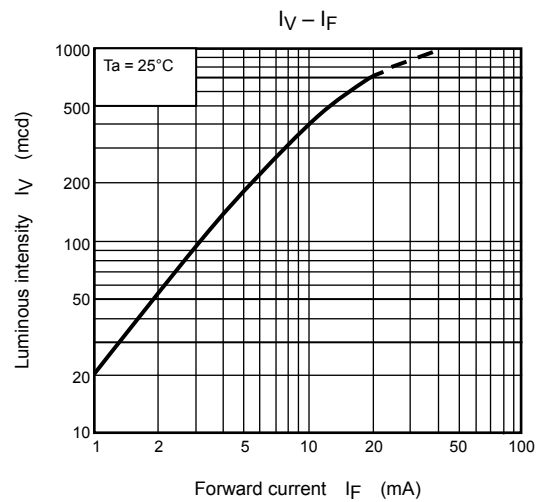
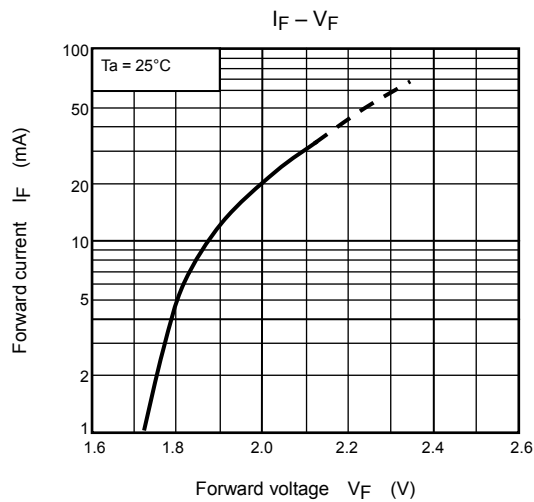
Please be careful of the followings

- Soldering temperature: 260°C max Soldering time: 3 s max
(Soldering portion of lead: Up to 1.6 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 1.6 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

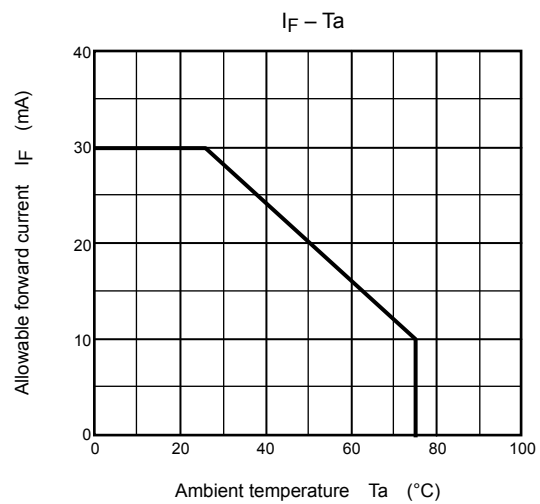
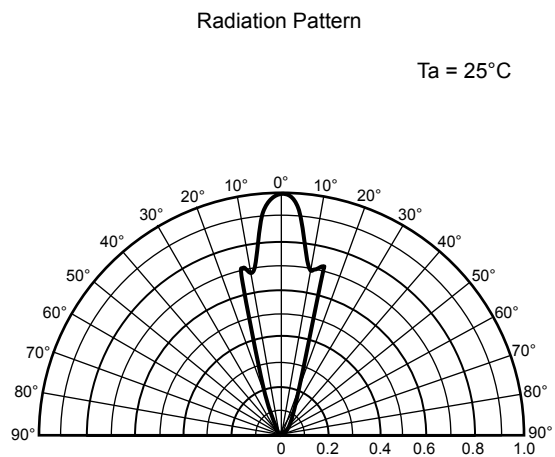
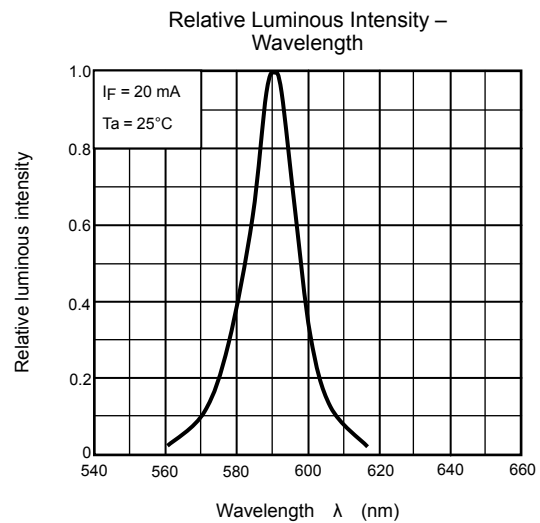
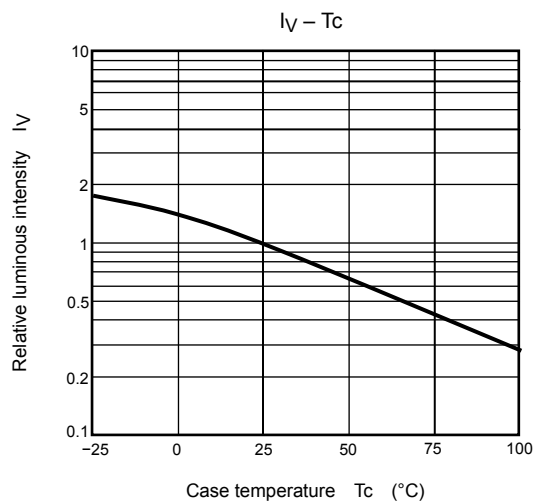
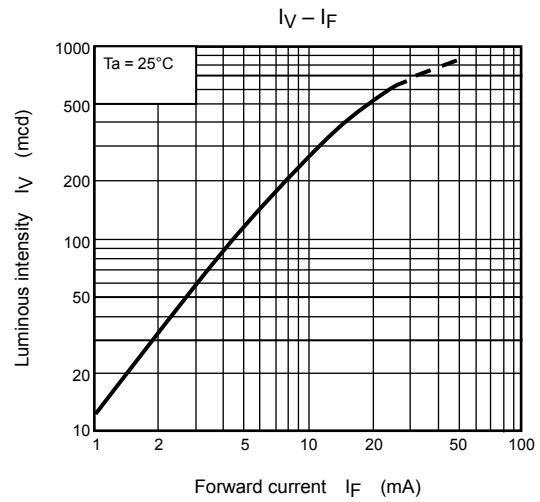
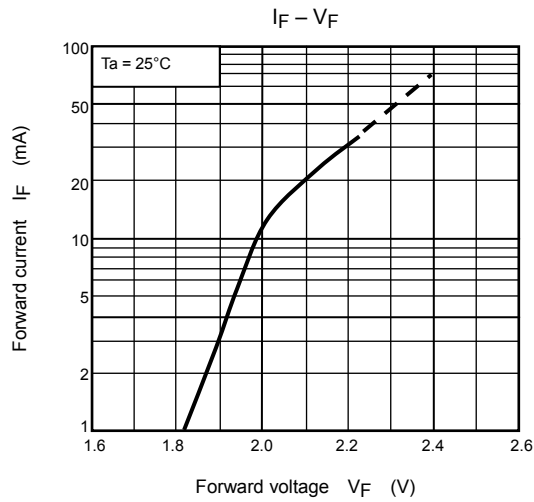
TLOU113P(F)



TLSU113P(F)



TLYU113P(F)



RESTRICTIONS ON PRODUCT USE

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